

### Description

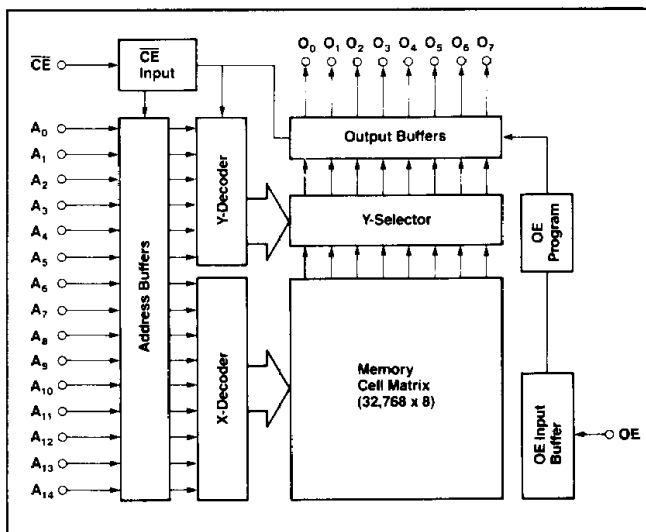
The μPD23C256E is a 262,144-bit Read-only Memory utilizing CMOS silicon gate technology. The device is static in operation, organized as 32,768 words by 8 bits, and has three-state outputs. All inputs and outputs are fully TTL-compatible. The Output Enable pin is mask-programmable and can be specified by selecting 1, 0, or don't-care data. The μPD23C256E is packaged in a 28-pin plastic (μPD23C256EC) DIP and a 28-pin miniflat package (μPD23C256EG). Pinout is compatible with μPD27256 EPROMs.

### Features

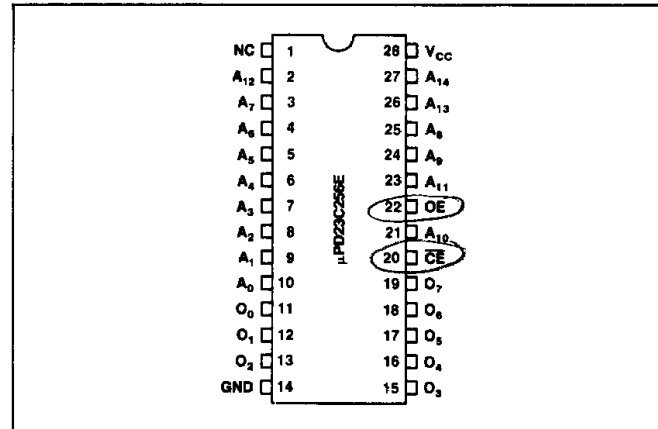
- 32,768-word by 8-bit organization
- I/O TTL-compatible
- Three-state output
- Single +2.5V to +6.0V power supply
- Available in plastic DIP and miniflat packages
- Low power consumption
  - Active: 40mA max
  - Standby: 30μA max
- 2 performance ranges:

| Device       | Access Time | Power Supply |         |
|--------------|-------------|--------------|---------|
|              |             | Active       | Standby |
| μPD23C256E   | 200ns       | 25mA         | 30μA    |
| μPD23C256E-1 | 150ns       | 30mA         | 30μA    |

### Block Diagram



### Pin Configuration



### Pin Identification

| Pin             |                                 |                                    |
|-----------------|---------------------------------|------------------------------------|
| No.             | Symbol                          | Description                        |
| 1               | NC                              | No Connection                      |
| 2-10, 21, 23-27 | A <sub>0</sub> -A <sub>14</sub> | Address Inputs                     |
| 11-13, 15-19    | O <sub>0</sub> -O <sub>7</sub>  | Data Outputs                       |
| 14              | GND                             | Ground                             |
| 20              | CE                              | Chip Enable                        |
| 22              | OE                              | Output Enable ①                    |
| 28              | V <sub>CC</sub>                 | Single +2.5V to +6.0V Power Supply |

Note: ① The active level of the OE input is specified by 0, 1, or x where x equals don't-care data.

## μPD23C256E

### Absolute Maximum Ratings\*

|                                  |                          |
|----------------------------------|--------------------------|
| Supply Voltage, $V_{CC}$         | -0.3V to +7V             |
| Input Voltage, $V_I$             | -0.3V to $V_{CC} + 0.3V$ |
| Output Voltage, $V_O$            | -0.3V to $V_{CC} + 0.3V$ |
| Operating Temperature, $T_{OPR}$ | -10°C to +70°C           |
| Storage Temperature, $T_{STG}$   | -65°C to +150°C          |

\*COMMENT: Exposing the device to stresses above those listed in Absolute Maximum Ratings could cause permanent damage. The device is not meant to be operated under conditions outside the limits described in the operational sections of this specification. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### Capacitance

$T_A = -10^\circ\text{C to } +70^\circ\text{C}$

| Parameter          | Symbol | Limits |     |     | Unit | Test Conditions   |
|--------------------|--------|--------|-----|-----|------|-------------------|
|                    |        | Min    | Typ | Max |      |                   |
| Input Capacitance  | $C_I$  |        | 10  |     | pF   | $f = 1\text{MHz}$ |
| Output Capacitance | $C_O$  |        | 15  |     | pF   | $f = 1\text{MHz}$ |

### DC Characteristics

$T_A = -10^\circ\text{C to } +70^\circ\text{C}; V_{CC} = +5.0V \pm 10\%$

| Parameter                   | Symbol    | Limits |     |                | Unit          | Test Conditions  |
|-----------------------------|-----------|--------|-----|----------------|---------------|--|
|                             |           | Min    | Typ | Max            |               |  |
| Input High Voltage          | $V_{IH}$  | 2.2    |     | $V_{CC} + 0.3$ | V             |  |
| Input Low Voltage           | $V_{IL}$  | -0.3   |     | 0.8            | V             |  |
| Output High Voltage         | $V_{OH}$  | 2.4    |     |                | V             | $I_{OH} = -400\mu\text{A}$                                 |
| Output Low Voltage          | $V_{OL}$  |        | 0.4 |                | V             | $I_{OL} = +3.2\text{mA}$                                   |
| Input Leakage Current High  | $I_{LH}$  |        | 10  |                | $\mu\text{A}$ | $V_I = V_{CC}$   |
| Input Leakage Current Low   | $I_{LL}$  |        | -10 |                | $\mu\text{A}$ | $V_I = 0V$   |
| Output Leakage Current High | $I_{LOH}$ |        | 10  |                | $\mu\text{A}$ | $V_O = V_{CC}$ (Chip deselected)                           |
| Output Leakage Current Low  | $I_{LOL}$ |        | -10 |                | $\mu\text{A}$ | $V_O = 0V$ (Chip deselected)                               |
| Power Supply Current        | $I_{CC1}$ |        | 14  | 25             | mA            | $\overline{CE} = V_{IL}$<br>μPD23C256E                     |
|                             | $I_{CC2}$ |        | 0.2 | 1.5            | mA            | $\overline{CE} = V_{IH}$<br>(Standby mode)<br>μPD23C256E-1 |
|                             | $I_{CC3}$ |        | 0.2 | 30             | $\mu\text{A}$ | $\overline{CE} = V_{CC} - 0.2V$<br>(Standby mode)          |

### DC Characteristics (Cont.)

$T_A = -10^\circ\text{C to } +70^\circ\text{C}; V_{CC} = +2.5V \text{ to } +6.0V$

| Parameter                   | Symbol    | Limits         |      |                 | Unit          | Test Conditions  |
|-----------------------------|-----------|----------------|------|-----------------|---------------|--|
|                             |           | Min            | Typ  | Max             |               |  |
| Input High Voltage          | $V_{IH}$  | 0.7 x $V_{CC}$ |      | $V_{CC} + 0.3V$ | V             |  |
| Input Low Voltage           | $V_{IL}$  | -0.3           |      | 0.55            | V             | $V_{CC} = 2.5V \text{ to } 4.5V$<br>$V_{CC} = 4.5V \text{ to } 6.0V$ |
| Output High Voltage         | $V_{OH}$  | 0.75 $V_{CC}$  |      |                 | V             | $I_{OH} = -400\mu\text{A}$   |
| Output Low Voltage          | $V_{OL}$  |                | 0.45 |                 | V             | $I_{OL} = +400\mu\text{A}$   |
| Input Leakage Current High  | $I_{LH}$  |                | 10   |                 | $\mu\text{A}$ | $V_I = V_{CC}$   |
| Input Leakage Current Low   | $I_{LL}$  |                | -10  |                 | $\mu\text{A}$ | $V_I = 0V$   |
| Output Leakage Current High | $I_{LOH}$ |                | 10   |                 | $\mu\text{A}$ | $V_O = V_{CC}$ (Chip deselected)                                     |
| Output Leakage Current Low  | $I_{LOL}$ |                | -10  |                 | $\mu\text{A}$ | $V_O = 0V$ (Chip deselected)   |
| Power Supply Current        | $I_{CC1}$ |                | 3    | 10              | mA            | $V_{CC} = +3.0V \pm 10\%$<br>μPD23C256E                              |
|                             |           |                | 6    | 18              | mA            | $V_{CC} = +5.0V \pm 10\%$  |
|                             |           |                | 3.5  | 10              | mA            | $V_{CC} = +3.0V \pm 10\%$<br>μPD23C256E-1                            |
|                             |           |                | 7    | 20              | mA            | $V_{CC} = +5.0V \pm 10\%$  |
|                             | $I_{CC3}$ |                | 0.1  | 30              | $\mu\text{A}$ | $V_{CC} = +3.0V \pm 10\%$<br>$\overline{CE} = V_{DD} - 0.2V$         |
|                             |           |                | 0.2  | 30              | $\mu\text{A}$ | $V_{CC} = +5.0V \pm 10\%$ (Standby mode)                             |

### AC Characteristics

$T_A = -10^\circ\text{C to } +70^\circ\text{C}; V_{CC} = +5.0V \pm 10\%$

| Parameter                 | Symbol    | Limits  |     |     |           |     |     | Unit | Test Conditions<br>① |
|---------------------------|-----------|---------|-----|-----|-----------|-----|-----|------|----------------------|
|                           |           | 23C256E |     |     | 23C256E-1 |     |     |      |                      |
|                           |           | Min     | Typ | Max | Min       | Typ | Max |      |                      |
| Access Time               | $t_{ACC}$ |         |     | 200 |           |     | 150 | ns   |                      |
| Chip Enable Access Time   | $t_{CE}$  |         |     | 200 |           |     | 150 | ns   |                      |
| Output Enable Access Time | $t_{OE}$  | 10      |     | 100 | 10        |     | 100 | ns   |                      |
| Output Hold Time          | $t_{OH}$  | 0       |     | 0   |           |     | 0   | ns   |                      |
| Output Disable Time       | $t_{DF}$  | 0       |     | 90  | 0         |     | 90  | ns   | ②                    |

Notes: ① Input voltage,  $t_p$ ,  $t_r = 20\text{ns}$ ;  
Input and output timing reference levels = 0.8V and 2.0V;  
Load = 1TTL + 100pF;  
②  $t_{DF}$  is specified from CE or OE, whichever occurs first.

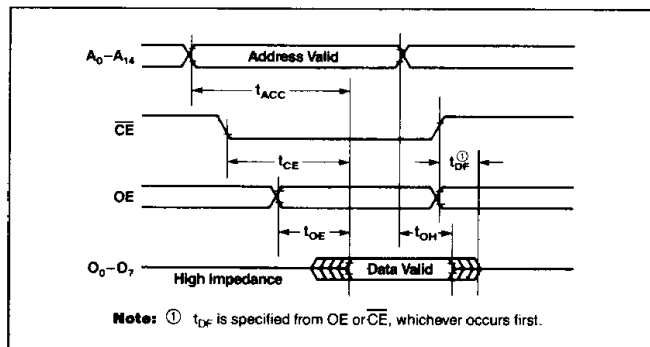
### AC Characteristics (Cont.)

$T_A = -10^\circ\text{C to } +70^\circ\text{C}; V_{CC} = +2.5V \text{ to } +6.0V$

| Parameter                 | Symbol    | Limits  |     |     |           |     |     | Unit | Test Conditions<br>① |
|---------------------------|-----------|---------|-----|-----|-----------|-----|-----|------|----------------------|
|                           |           | 23C256E |     |     | 23C256E-1 |     |     |      |                      |
|                           |           | Min     | Typ | Max | Min       | Typ | Max |      |                      |
| Access Time               | $t_{ACC}$ |         |     | 650 |           |     | 500 | ns   |                      |
| Chip Enable Access Time   | $t_{CE}$  |         |     | 650 |           |     | 500 | ns   |                      |
| Output Enable Access Time | $t_{OE}$  |         |     | 300 |           |     | 300 | ns   |                      |
| Output Hold Time          | $t_{OH}$  | 0       |     | 0   |           |     | 0   | ns   |                      |
| Output Disable Time       | $t_{DF}$  | 0       |     | 250 | 0         |     | 250 | ns   | ②                    |

Notes: ① Input and output timing reference levels =  $V_{IL}$  and  $V_{IH}$ ;  
Load = 150pF;  
②  $t_{DF}$  is specified from CE or OE, whichever occurs first.

### Timing Waveform



### Definitions

#### Access Time, $t_{ACC}$

Access time is the maximum time between the application of a valid address and the corresponding valid data out.

#### Chip Enable Access Time, $t_{CE}$

The maximum time between application of a valid chip enable input and the corresponding valid outputs.

#### Output Enable Access Time, $t_{OE}$

The maximum time between application of a valid output enable input and the corresponding valid outputs.

#### Output Hold Time, $t_{OH}$

Output hold time is the minimum time after an address change that the previous data remains valid.

#### Output Disable Time, $t_{DF}$

Output disable time is the delay between chip selects becoming false and output stages going to the high-impedance state.  $t_{DF}$  is specified from  $\overline{CE}$  or OE, whichever occurs first.